

CUSTOMER 客户:

规格书编号

SPEC NO:

产品规格书 SPECIFICATION

PRODUCT 产品:	SAW FILTER		
MODEL NO 型 号:	HDBF115A SIP5D		
PREPARED 编 制:	CHECKED 审 核:		
APPROVED 批 准:	DATE 日 期	月: 2011-2-22	
客户确认 CUSTOMER RECEIVED:			
审核 CHECKED	批准 APPROVED	日期 DATE	

无锡市好达电子有限公司 Shoulder Electronics Limited

HDBF115A SIP5D

更改历史记录 History Record

更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark

1.SCOPE

SAW FILTER

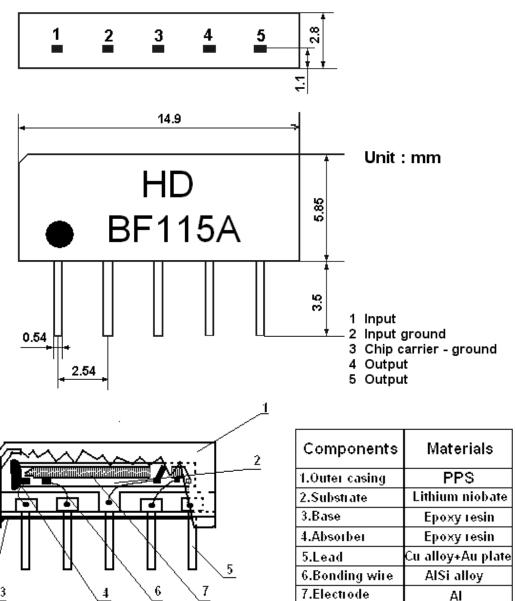
SHOULDER'S SAW filter series have broad line up products meeting all broadcast standard including NTSC,PAL and SECAM systems. These filters are composed of two interdigital transducers on a single-crystal. piezoelectrical chip. they are used in electronic equipments such as TV and so on.

2.Construction

2.1 Dimension and materials

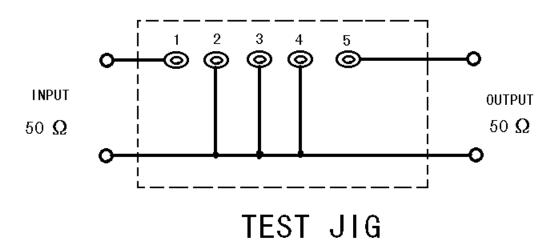
Manufacturer's name: SHOULDER ELECTRONICS Co. LTD(CHINA)







2.2. Circuit construction, measurement circuit



3. Characteristics

Items	Conditions	Specifications
Standard atmospheric conditions	Unless otherwise specified, the standard rang of atmospheric conditions for making measurements and tests is as follows; Ambient temperature : 15°C to 35°C Relative humidity : 25% to 85% Air pressure : 86kPa to 106kPa	
Operating temperature rang	Operating temperature rang is the rang of ambient temperatures in which the filter can be operated continuously. $-20^{\circ}\text{C} \sim +60^{\circ}\text{C}$	There shall be no damage.
Storage temperature rang	Storage temperature rang is the rang of ambient temperatures at which the filter can be stored without damage. Conditions are as specified elsewhere in these specifications. $-40^{\circ}\text{C} \sim +70^{\circ}\text{C}$	
Reference	+25℃	
temperature		

3.1 Maximum Rating

DC voltage	VDC	12	\mathbf{V}	Between any terminals
AC voltage	Vpp	10	V	Between any terminals



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3.2 Electrical Characteristics

Source impedance $Z_{S=50 \Omega}$

Load impedance $Z_L=50 \Omega$ $T_A=25 ^{\circ}C$

Item	Freq	min	typ	max	
Center frequency	Fo	_	115.24	-	MHz
Insertion attenuation Reference level	115.24MHz	21.0	22.5	24.0	dB
Amplitude(p-p)	114.0~116.5 MHz		0.6		dB
	$B_{1.5dB}$	1	2.9	-	MHz
Pass bandwidth	$\mathrm{B}_{15\mathrm{dB}}$	1	3.9	-	MHz
	${ m B}_{ m 30dB}$	1	4.4	-	MHz
	105.0~111.0 MHz	40.0	45.0	-	dB
D.1.C. W. C.	111.0~112.5 MHz	35.0	45.0	-	dB
Relative attenuation	118.0~119.5 MHz	36	46.0	-	dB
	119.5~125.0 MHz	40	45	-	dB
Reflected wave signa					
1.5 μ s6.0 μ s after main pulse (Test pulse 250 μ s, carrier frequency 115.24MHz)		38.0	48.0	-	dB
Group delay ripple(p-p) 113,79~116.69			70		ns
Impedance at 36.00MHz					
Input: Zin =Rin //Cin			0.2//16.0		KΩ//pF
Output: Zout=Rout//Cout			0.1//23.4		K Ω // p F
Temperature coefficient			-1	8	ppm/k

3.3 Environmental Performance Characteristics

Item	Condition	Specifications
High	The specimen shall be store at a temperature of	
temperature	80±2°C for 96±4h. Then it shall be subjected to	
	standard atmospheric conditions for 1h, after	
	which measurement shall be made within 1h.	
Low	The specimen shall be store at a temperature of	Mechanical
temperature	-20±3°C for 96±4h. Then it shall be subjected to	characteristics and
	standard atmospheric conditions for 1h, after	specifications in
	which measurement shall be made within 1h. electrical	
Humidity	The specimen shall be store at a temperature of characteristics shall	



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	40.200 11 1 1 1 1 1 2 2 2 2 2 2	co/ 1	
	$40\pm2^{\circ}$ C with relative humidity of 90% to 90		
	for 96±4h. Then it shall be subjected to standa		
	atmospheric conditions for 1h, after wh	ich excessive change in	
	measurement shall be made within 1h.	appearance.	
Thermal	The specimen shall be subjected to 8 continuo	ous	
shock	cycles each as shown below. Then it shall	be	
	subjected to standard atmospheric conditions	for	
	1h, after which measurement shall be ma	ade	
	within 1h.		
	Temperature Duration		
	1 +25 °C=>-40 °C 0.5h		
	2 -40 °C 4h		
	3 -40 °C=>+85 °C 2h		
	4 +85 °C 4h		
	5 +85 °C=>+25 °C 0.5h		
	6 +25 °C 1h		
Resistance to			
	Reflow soldering method		
Soldering	Peak: 255 ±5 °C, 220 ±5 °C, 40s		
heat	At electrode temperature of the specimen.		
	Temperature profile of reflow soldering		
	Soldering		
	250 — Clauseelles (Steve et		
	200 40 s Slow cooling (Store		
	Pre-heating		
	250 Slow cooling (Store at room temperature) Pre-heating 150 Pre-heating		
	8 100 -		
	50		
	1 to 2 min. 10s 2 min. or more		
	1 to 2 min. 10s 2 min. or more		
	The specimen shall be passed through the refl-	ow	
	furnace with the condition shown in the abo	ove	
	profile for 1 time.		
	The specimen shall be stored at standard	ard	
	atmospheric conditions for 1h, after which	the	
	measurement shall be made. Test board shall	be	
	1.6 mm thick. Base material shall be glass fab	pric	
	base epoxy resin.		
Solder ability	Immerse the pins melt solder at 260°C+5/-0	O°C More then 95% of	
	for 5 sec.	total area of the	
		pins should be	
		covered with solder	
		covered with solder	

3.4 Mechanical Test

Items	Conditions	Specifications
Vibration	600-3300rpm amplitude 1.5mm	
	3 directions 2 H each	
Drop	On maple plate from 1 m high 3 times	
		There shall be no
Lead pull	Pull with 1 kg force for 30 seconds	damage.
Lead bend	90° bending with 500g weigh 2 times	

3.5 Voltage Discharge Test

Item	Condition	Specifications
Surge	Between any two electrode	
	T _{100V} T _{1000p} F 4Mohm	There shall be no damage

3.6 Frequency response

